

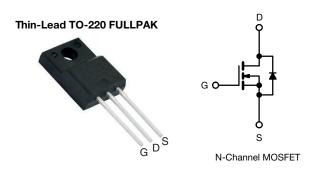
Vishay Siliconix

ROHS COMPLIANT

HALOGEN

FREE

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V_{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$ 0.088				
Q _g max. (nC)	53				
Q _{gs} (nC)	12				
Q _{gd} (nC)	11				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free and halogen-free	SiHA105N60EF-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C				LINALT	LINUT	
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	- v	
Gate-source voltage			V _{GS}	± 30		
Continuous drain ourrant $(T_{1} - 150 ^{\circ}\text{C})^{\circ}$	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	12		
Continuous drain current ($T_J = 150 \text{ °C}$) ^e	V _{GS} at 10 V	T _C = 100 °C		8	А	
Pulsed drain current ^a			I _{DM}	73	1	
Linear derating factor				0.28	W/°C	
Single pulse avalanche energy ^b			E _{AS}	226	mJ	
Maximum power dissipation			PD	35		
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		dv/dt	70	1//20	
Reverse diode dv/dt d			uv/di	50	V/ns	
Soldering recommendations (peak temperature) ^c	For 10 s			260	°C	
Mounting torque, M3 screw	•			0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,$ I_{AS} = 4 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, di/dt = 400$ A/µs, starting $T_J = 25 \ ^\circ C$

e. Limited by maximum junction temperature

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1 For technical questions, contact: <u>hvm@vishay.com</u>



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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		65		80.00		
Maximum junction-to-case (drain)	R _{thJC}	- 3.6			°C/W			
	•							
SPECIFICATIONS (T _J = 25 °C, u	nless otherwi	se noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static					<u> </u>	1	1	1
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0	V, I _D = 250	μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C, I _D :	= 1 mA	-	0.63	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	$V_{DS} = V_0$	_{GS} , I _D = 250	μA	3	-	5	V
Osta saura laskara	1	V _G	_S = ± 20 V		-	-	± 100	nA
Gate-source leakage	I _{GSS}	V _G	_S = ± 30 V		-	-	± 1	μA
		V _{DS} = 480 V, V _{GS} = 0 V		-	-	1	μA	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V, V	′ _{GS} = 0 V, T _J	= 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V I _D = 13 A		-	0.088	0.102	Ω	
Forward transconductance ^a	9 _{fs}	V _{DS} = 20 V, I _D = 13 A		-	8	-	S	
Dynamic								
Input capacitance	C _{iss}	V	_{GS} = 0 V,		-	1804	-	
Output capacitance	C _{oss}	$V_{DS} = 100 V,$ f = 1 MHz		-	82	-		
Reverse transfer capacitance	C _{rss}			-	6	-		
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	63	-	pF	
Effective output capacitance, time related ^b	C _{o(tr)}			-	407	-		
Total gate charge	Qg	V _{GS} = 10 V I _D = 11 A, V _{DS} = 480 V		-	35	53		
Gate-source charge	Q _{gs}			-	12	-	nC	
Gate-drain charge	Q _{gd}			-	11	-		
Turn-on delay time	t _{d(on)}				-	20	40	
Rise time	t _r	V_{DD} = 480 V, I _D = 13 A, V _{GS} = 10 V, R _g = 9.1 Ω f = 1 MHz, open drain		-	28	56	- ns	
Turn-off delay time	t _{d(off)}			-	39	78		
Fall time	t _f			-	19	38		
Gate input resistance	Rg			0.3	0.7	1.4	Ω	
Drain-Source Body Diode Characteristic	s							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29	•	
Pulsed diode forward current	I _{SM}			-	-	73	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I	_S = 13 A, V _G	_{iS} = 0 V	-	-	1.2	V
				1				

Notes

Reverse recovery time

Reverse recovery charge

Reverse recovery current

a. Coss(er) is a fixed capacitance that gives the same energy as Coss while VDS is rising from 0 % to 80 % VDSS

t_{rr}

Q_{rr}

I_{RRM}

b. C_{oss(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

 $\begin{array}{l} T_J=25 ~^\circ C, ~I_F=I_S=13 ~A, \\ di/dt=100 ~A/\mu s, ~V_R=400 ~V \end{array}$

250

1.6

-

ns

μC

А

-125

0.8

12

_

-

-



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

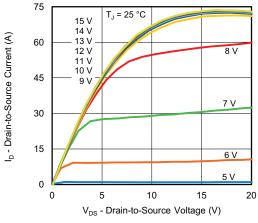


Fig. 1 - Typical Output Characteristics

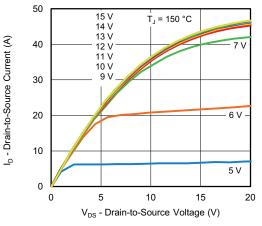


Fig. 2 - Typical Output Characteristics

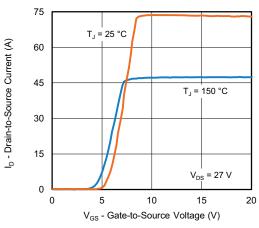


Fig. 3 - Typical Transfer Characteristics

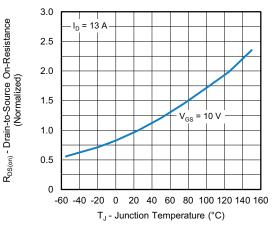


Fig. 4 - Normalized On-Resistance vs. Temperature

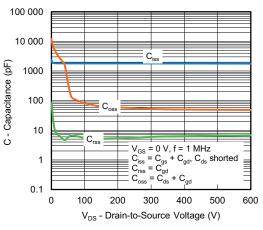
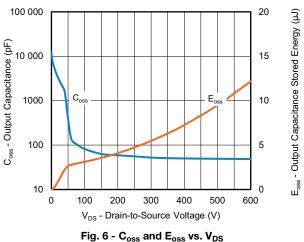


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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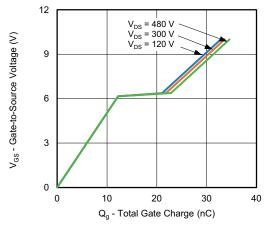


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

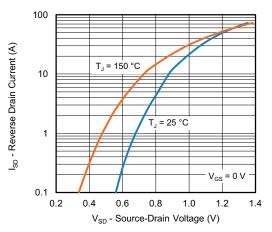


Fig. 8 - Typical Source-Drain Diode Forward Voltage

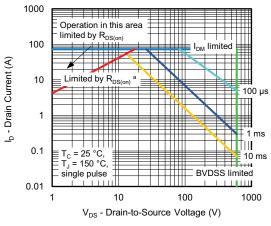


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

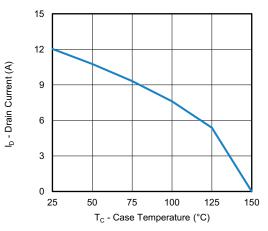


Fig. 10 - Maximum Drain Current vs. Case Temperature

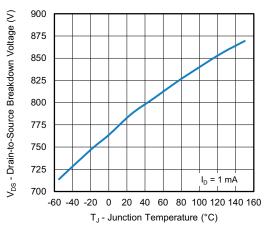


Fig. 11 - Temperature vs. Drain-to-Source Voltage

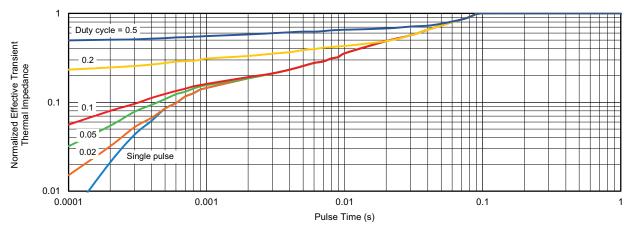
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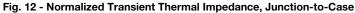
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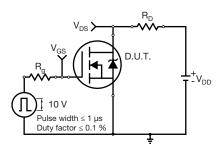


Fig. 13 - Switching Time Test Circuit

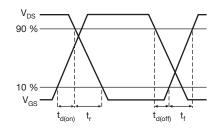


Fig. 14 - Switching Time Waveforms

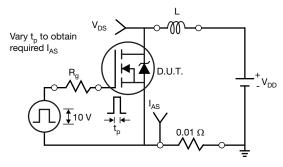


Fig. 15 - Unclamped Inductive Test Circuit

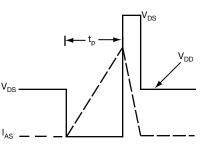


Fig. 16 - Unclamped Inductive Waveforms

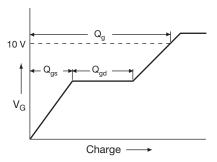


Fig. 17 - Basic Gate Charge Waveform

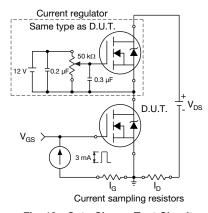


Fig. 18 - Gate Charge Test Circuit

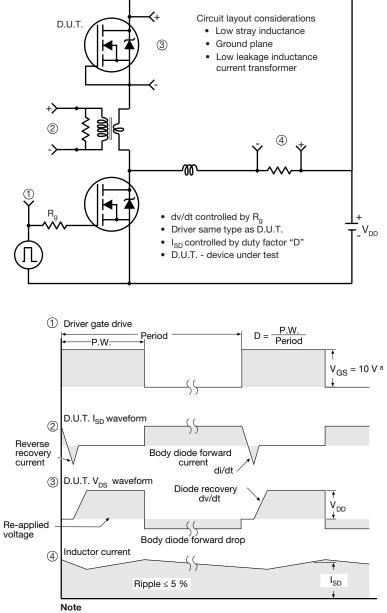
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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	



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